ne<mark>x</mark>peria

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω

Rev. 4 — 6 December 2011

Product data sheet

1. Product profile

1.1 General description

NPN/NPN double Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

| Table 1. | Product | overview |
|----------|---------|-----------|
| | | 0.0.0.0.0 |

| Type number | Package | | NPN/PNP PNP/PNP Package | | U |
|-------------|---------|-------|-------------------------|------------|---------------------------|
| | NXP | JEITA | complement | complement | configuration |
| PEMH13 | SOT666 | - | PEMD13 | PEMB13 | ultra small and flat lead |
| PUMH13 | SOT363 | SC-88 | PUMD13 | PUMB13 | very small |

1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

1.4 Quick reference data

| Table 2. | Quick reference data | | | | | |
|------------------|---------------------------|------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Per trans | istor | | | | | |
| V _{CEO} | collector-emitter voltage | open base | - | - | 50 | V |
| I _O | output current | | - | - | 100 | mA |
| R1 | bias resistor 1 (input) | | 3.3 | 4.7 | 6.1 | kΩ |
| R2/R1 | bias resistor ratio | | 8 | 10 | 12 | |



- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

| | 2 3 *sym063*

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω

2. Pinning information

| Table 3. | Pinning | | |
|----------|------------------------|--------------------|----------------|
| Pin | Description | Simplified outline | Graphic symbol |
| 1 | GND (emitter) TR1 | | |
| 2 | input (base) TR1 | | |
| 3 | output (collector) TR2 | | |
| 4 | GND (emitter) TR2 | | |
| 5 | input (base) TR2 | | |
| 6 | output (collector) TR1 | 001aab555 | |

3. Ordering information

| Table 4. Ordering information | | | | |
|-------------------------------|---------|--|---------|--|
| Type number | Package | | | |
| | Name | Description | Version | |
| PEMH13 | - | plastic surface-mounted package; 6 leads | SOT666 | |
| PUMH13 | SC-88 | plastic surface-mounted package; 6 leads | SOT363 | |

4. Marking

| Table 5. Marking codes | |
|------------------------|-----------------------------|
| Type number | Marking code ^[1] |
| PEMH13 | 21 |
| PUMH13 | H0* |

[1] * = placeholder for manufacturing site code

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω

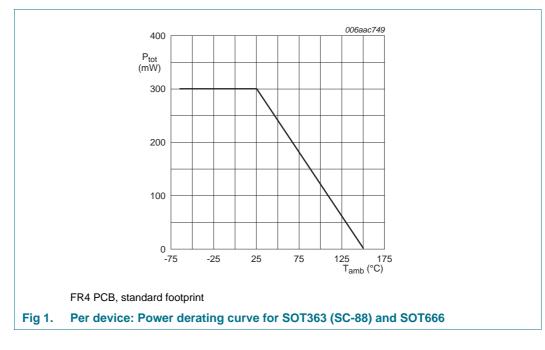
5. Limiting values

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|---------------------------|--|------------|-----|------|------|
| Per transis | stor | | | | | |
| V _{CBO} | collector-base voltage | open emitter | | - | 50 | V |
| V _{CEO} | collector-emitter voltage | open base | | - | 50 | V |
| V _{EBO} | emitter-base voltage | open collector | | - | 5 | V |
| VI | input voltage | | | | | |
| | positive | | | - | +30 | V |
| | negative | | | - | -5 | V |
| lo | output current | | | - | 100 | mA |
| I _{CM} | peak collector current | single pulse; t _p ≤ 1 ms | | - | 100 | mA |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | | | | |
| | PEMH13 (SOT666) | | [1][2] | - | 200 | mW |
| | PUMH13 (SOT363) | | <u>[1]</u> | - | 200 | mW |
| Per device | ; | | | | | |
| P _{tot} | total power dissipation | $T_{amb} \leq 25 ~^{\circ}C$ | | | | |
| | PEMH13 (SOT666) | | [1][2] | - | 300 | mW |
| | PUMH13 (SOT363) | | <u>[1]</u> | - | 300 | mW |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -65 | +150 | °C |
| T _{stg} | storage temperature | | | -65 | +150 | °C |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω



Thermal characteristics 6.

| <u> </u> | - | A 11/1 | | _ | | |
|----------------------|---|---------------|-----------------|-------|-----|------|
| Symbol | Parameter | Conditions | Mir | п Тур | Max | Unit |
| Per transi | istor | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | | | | |
| | PEMH13 (SOT666) | | <u>[1][2]</u> | - | 625 | K/W |
| | PUMH13 (SOT363) | | <u>[1]</u> _ | - | 625 | K/W |
| Per devic | e | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | | | | |
| | PEMH13 (SOT666) | | <u>[1][2]</u> _ | - | 417 | K/W |
| | PUMH13 (SOT363) | | <u>[1]</u> _ | - | 417 | K/W |

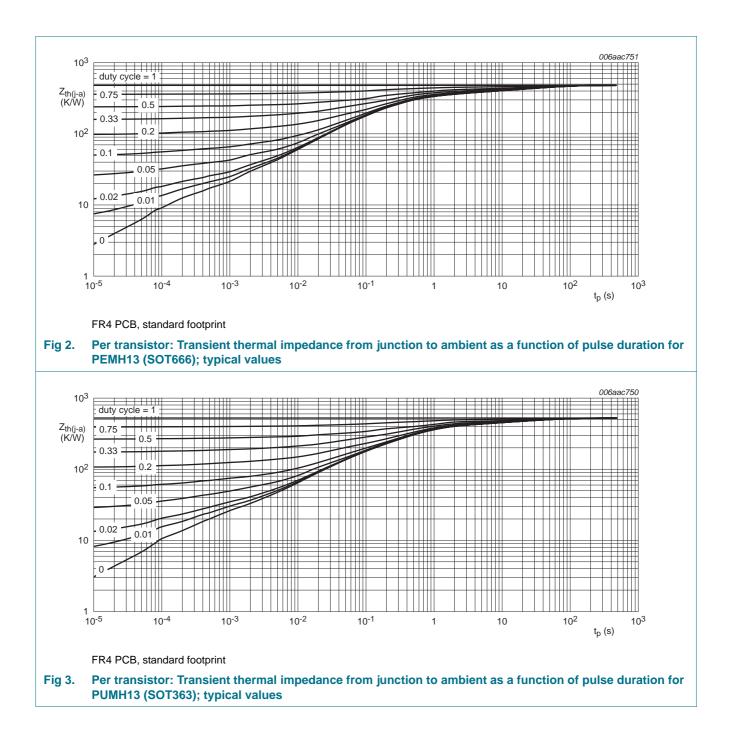
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

PEMH13_PUMH13

PEMH13; PUMH13

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω



7. Characteristics

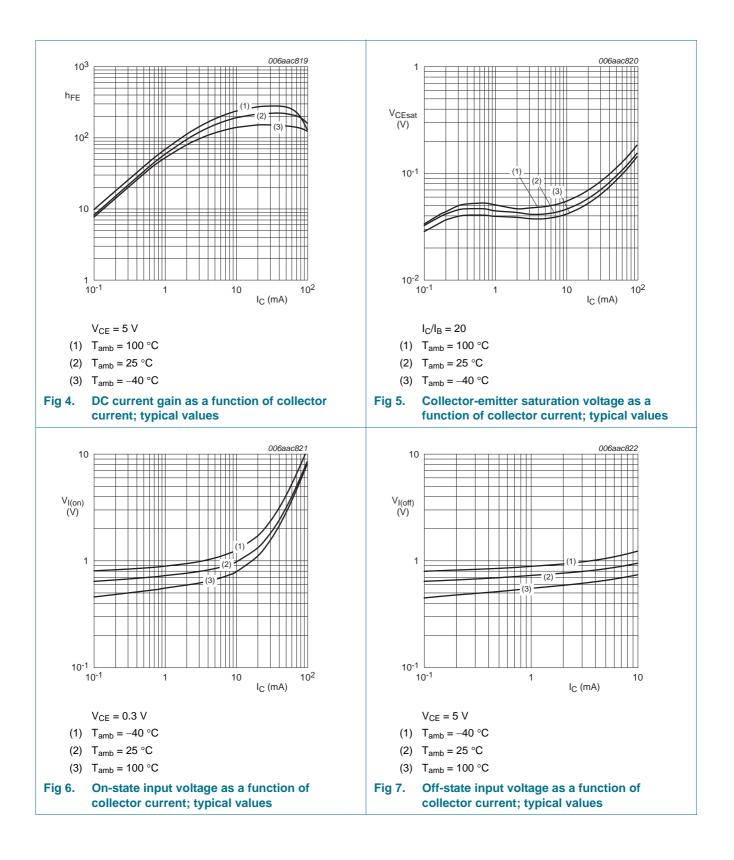
| Table 8. $T_{amb} = 25$ | Characteristics 5 °C unless otherwise spe | cified. | | | | |
|--------------------------------|---|--|--------------|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Per trans | sistor | | | | | |
| I _{CBO} | collector-base cut-off current | $V_{CB} = 50 \text{ V}; \text{ I}_{E} = 0 \text{ A}$ | - | - | 100 | nA |
| I _{CEO} | collector-emitter cut-off | $V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$ | - | - | 1 | μΑ |
| | current | $V_{CE} = 30 \text{ V}; I_B = 0 \text{ A};$ $T_j = 150 \text{ °C}$ | - | - | 5 | μΑ |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$ | - | - | 170 | μA |
| h _{FE} | DC current gain | $V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA}$ | 100 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_{C} = 5 \text{ mA}; I_{B} = 0.25 \text{ mA}$ | - | - | 100 | mV |
| V _{I(off)} | off-state input voltage | V_{CE} = 5 V; I_{C} = 100 μ A | - | 0.6 | 0.5 | V |
| V _{I(on)} | on-state input voltage | $V_{CE} = 0.3 \text{ V}; I_{C} = 5 \text{ mA}$ | 1.3 | 0.9 | - | V |
| R1 | bias resistor 1 (input) | | 3.3 | 4.7 | 6.1 | kΩ |
| R2/R1 | bias resistor ratio | | 8 | 10 | 12 | |
| C _c | collector capacitance | $\label{eq:VCB} \begin{array}{l} V_{CB} = 10 \; V; I_E = i_e = 0 \; A; \\ f = 1 \; MHz \end{array}$ | - | - | 2.5 | pF |
| f _T | transition frequency | $V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz | <u>[1]</u> _ | 230 | - | MHz |

[1] Characteristics of built-in transistor

PEMH13_PUMH13 Product data sheet

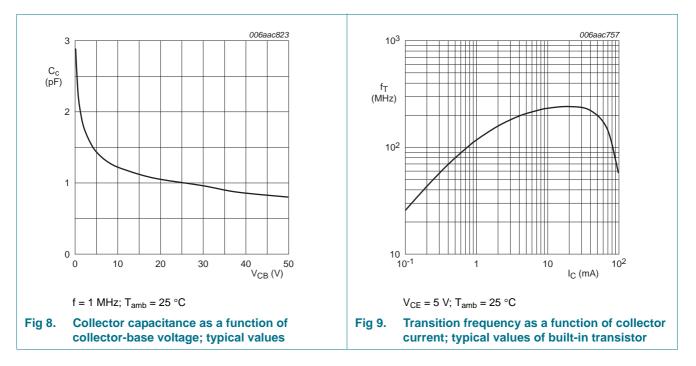
PEMH13; PUMH13

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω



PEMH13; PUMH13

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω

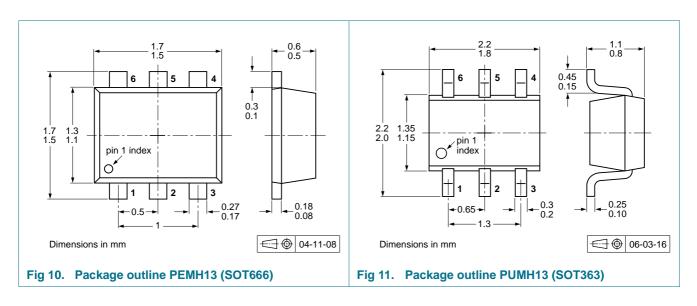


8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



PEMH13_PUMH13

10. Packing information

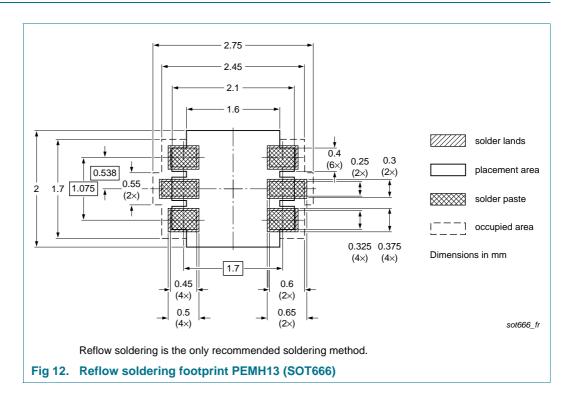
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

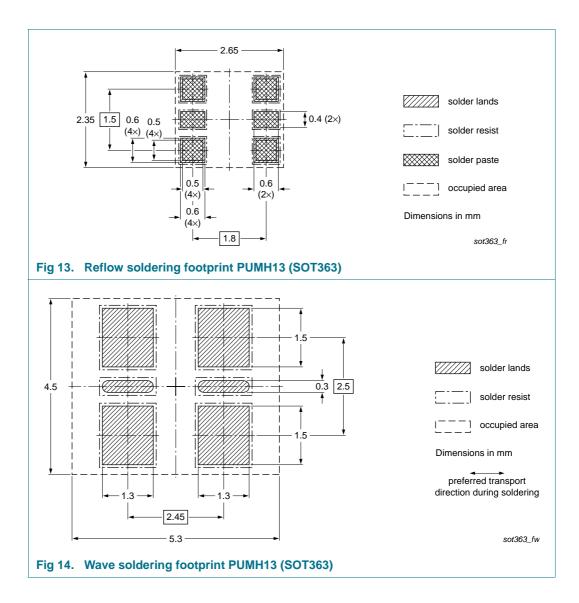
| Туре | Package | Package Description | | | Packing quantity | | | |
|--------|---------|------------------------------------|-----|------|------------------|------|-------|--|
| number | | | | 3000 | 4000 | 8000 | 10000 | |
| PEMH13 | SOT666 | 2 mm pitch, 8 mm tape and reel | | - | - | -315 | - | |
| | | 4 mm pitch, 8 mm tape and reel | | - | -115 | - | - | |
| PUMH13 | SOT363 | 4 mm pitch, 8 mm tape and reel; T1 | [2] | -115 | - | - | -135 | |
| | | 4 mm pitch, 8 mm tape and reel; T2 | [3] | -125 | - | - | -165 | |

- [1] For further information and the availability of packing methods, see <u>Section 14</u>.
- [2] T1: normal taping
- [3] T2: reverse taping

11. Soldering



NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω



PEMH13_PUMH13
Product data shee

12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|-------------------|---|------------------------------|---------------|-------------------|--|--|
| PEMH13_PUMH13 v.4 | 20111206 | Product data sheet | - | PEMH13_PUMH13 v.3 | | |
| Modifications: | The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. | | | | | |
| | • Legal texts have been adapted to the new company name where appropriate. | | | | | |
| | Section 1 "Product profile": updated | | | | | |
| | Section 4 "I | Marking": updated | | | | |
| | • Figure 1 to 9: added | | | | | |
| | <u>Section 5 "Limiting values"</u>: updated | | | | | |
| | <u>Section 6 "Thermal characteristics"</u>: updated | | | | | |
| | <u>Table 8 "Characteristics"</u>: V_{i(on)} redefined to V_{I(on)} on-state input voltage, V_{i(off)} redefined to V_{I(off)} off-state input voltage, I_{CEO} updated, f_T added | | | | | |
| | <u>Section 8 "Test information"</u> : added | | | | | |
| | <u>Section 9 "Package outline"</u>: superseded by minimized package outline drawing | | | | | |
| | Section 10 "Packing information": added | | | | | |
| | <u>Section 11 "Soldering"</u>: added | | | | | |
| | Section 13 | "Legal information": updated | | | | |
| PEMH13_PUMH13 v.3 | 20040414 | Product data sheet | - | PEMH13_PUMH13 v.2 | | |
| PEMH13_PUMH13 v.2 | 20031107 | Product specification | - | PEMH13 v.1 | | |
| PEMH13 v.1 | 20011213 | Preliminary specification | - | - | | |

PEMH13_PUMH13

13. Legal information

13.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

13.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product sole and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

PEMH13_PUMH13

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

14. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

PEMH13; PUMH13

NPN/NPN resistor-equipped transistors; R1 = 4.7 k Ω , R2 = 47 k Ω

15. Contents

| 1 | Product profile 1 |
|------|---------------------------|
| 1.1 | General description 1 |
| 1.2 | Features and benefits 1 |
| 1.3 | Applications 1 |
| 1.4 | Quick reference data 1 |
| 2 | Pinning information 2 |
| 3 | Ordering information 2 |
| 4 | Marking 2 |
| 5 | Limiting values 3 |
| 6 | Thermal characteristics 4 |
| 7 | Characteristics 6 |
| 8 | Test information 8 |
| 8.1 | Quality information 8 |
| 9 | Package outline 8 |
| 10 | Packing information 9 |
| 11 | Soldering 9 |
| 12 | Revision history 11 |
| 13 | Legal information 12 |
| 13.1 | Data sheet status 12 |
| 13.2 | Definitions 12 |
| 13.3 | Disclaimers |
| 13.4 | Trademarks 13 |
| 14 | Contact information 13 |
| 15 | Contents 14 |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 6 December 2011 Document identifier: PEMH13_PUMH13

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Nexperia:

PEMH13,115 PUMH13,115 PEMH13,315 PUMH13F